



An Additively Manufactured Deployable Radiator with Oscillating Heat Pipes (AMDROHP) to Enable High Power Lunar CubeSats

Cooperative Agreement (CA): 80NSSC20M0085



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Agenda

- Objectives
- Oscillating heat pipes
- Flexible joint
- Radiator
- Spacecraft
- Summary
- Next steps

Objectives

- Develop CubeSat that incorporates an additively manufactured deployable radiator with oscillating heat pipes (AMDROHP) capable of dissipating 50 W in Low Earth Orbit
- Develop a flexible OHP joint with a conductance of ~6 W/K that can fit in a CubeSat package.
- Design a CubeSat mission and integrate AMDROHP into CubeSat design.



Oscillating Heat Pipes (OHP)

- Two-phase heat transfer device
- Self excited oscillating motion through fluid evaporation and condensation
- Effective thermal conductivities in excess of >2,000 W/(mK)



Flexible Joint

Objective: Design a flexible joint allows for fluid flow between evaporator and condenser

Topics:

- Design exploration
- Analysis and experimentation



Joint Design – Design Exploration



Joint Design – Analysis and Experimentation





Joint Design – Analysis and Experimentation







Radiator

Topics:

- Oscillating heat pipes design considerations
- Additive manufacturing
- Radiator design
- Current design



Radiator – OHP Design Considerations

- Channel Diameter
- Turn Radius
- Working Fluid
- Number of turns
- Heat input



- Condenser temperature
- Relative size of evaporator, condenser and adiabatic regions
- Expected performance: ~4-6 W/C

Radiator – Additive manufacturing

- Broadens design space
- Complex geometries
- Rapid prototyping





Radiator Design



Current Design



- 18 Joints/Turns
- Aluminum 6061-T6
- Assumed Working Fluid: R123

Current Design





Spacecraft

Topics:

- Spacecraft thermal model
- Spacecraft thermal performance



Spacecraft Thermal Model



Spacecraft Thermal Performance



Summary of Design

- Volume: ~220 cm³/radiator
- Mass: ~650 g/radiator
- Power: Passive
- Cost: N/A
- Heat Rejection:
 - − 25 W per radiator (50 W total) \rightarrow <53°C at evaporator
 - 50 W for one radiator \rightarrow ~65°C at evaporator
- Expected conductance: ~4-6 W/K

Next Steps

- CubeSat-radiator integration
- OHP performance testing
- Further mechanical testing
- TVAC testing
- Follow-on project
- CSLI launch

Thank You!









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